

NCE N-Channel Super Trench II Power MOSFET

Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

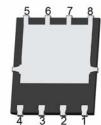
General Features

- V_{DS} =100V, I_D =75A $R_{DS(ON)}$ =7.0m Ω , typical@ V_{GS} =10V $R_{DS(ON)}$ =9.2m Ω , typical@ V_{GS} =4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

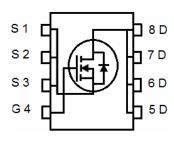
DFN 5X6







Bottom View



Schematic Diagram

Package Marking and Ordering Information

		<u> </u>			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P078N10AG	NCEP078N10AG	DFN5X6-8L	-	_	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	75	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	54	Α
Pulsed Drain Current	I _{DM}	300	Α
Maximum Power Dissipation	P _D	100	W
Derating factor		0.8	W/°C
Single pulse avalanche energy (Note 4)	E _{AS}	420	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Case	R _{eJC}	1.25	°C/W
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Electrical Characteristics (T_C=25°C unless otherwise noted)

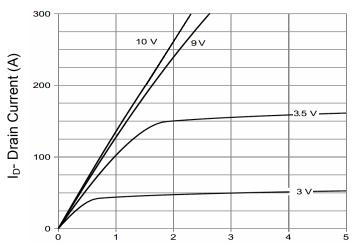
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	rain-Source Breakdown Voltage BV _{DSS}		100		-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA	
On Characteristics (Note 3)	On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.7	2.2	V	
Drain Source On State Registeres		V _{GS} =10V, I _D =37.5A	-	7.0	7.8	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =37.5A	-	9.0	10.5	mΩ	
Forward Transconductance	g FS	V _{DS} =5V,I _D =37.5A		60	-	S	
Dynamic Characteristics (Note3)							
Input Capacitance	C _{lss}	V _{DS} =50V,V _{GS} =0V, F=1.0MHz	-	3450	-	pF	
Output Capacitance	C _{oss}		-	305	-	pF	
Reverse Transfer Capacitance	C _{rss}	r=1.0lvlm2	-	8	-	pF	
Switching Characteristics (Note 3)							
Turn-on Delay Time	t _{d(on)}		-	16	-	nS	
Turn-on Rise Time	t _r	V_{DD} =50V, I_{D} =37.5A	-	11	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =1.6 Ω	-	35	-	nS	
Turn-Off Fall Time	t _f		-	9	-	nS	
Total Gate Charge	Qg	\/ -50\/1 -27.54	-	70	-	nC	
Gate-Source Charge	Q _{gs}	V_{DS} =50V, I_{D} =37.5A,	-	14.5	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	16.8	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 2)	V _{SD}	V _{GS} =0V,I _S =37.5A	-	-	1.2	V	
Diode Forward Current	Is		-	-	75	Α	
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C$, $I_F = 37.5A$	-	60	-	nS	
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	106	-	nC	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 3. Guaranteed by design, not subject to production
- 4. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{DD}$ =50 V ,V $_{G}$ =10 V ,L=0.25 mH ,Rg=25 Ω

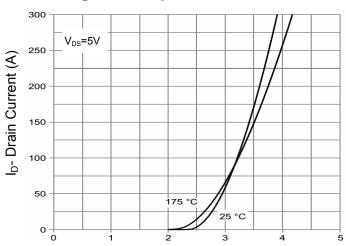


Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

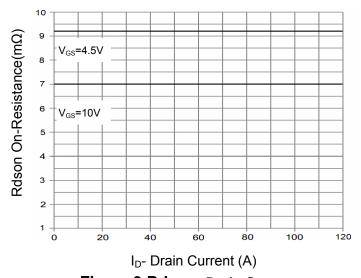


Figure 3 Rdson- Drain Current

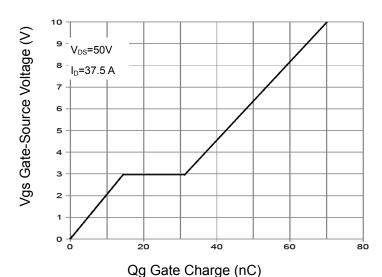


Figure 4 Gate Charge

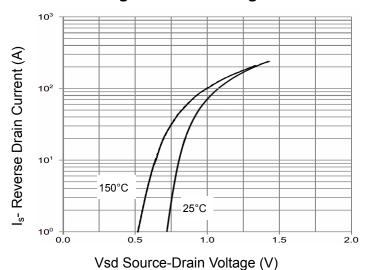


Figure 5 Source- Drain Diode Forward

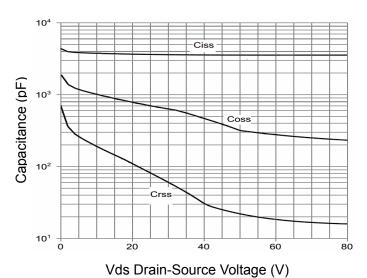
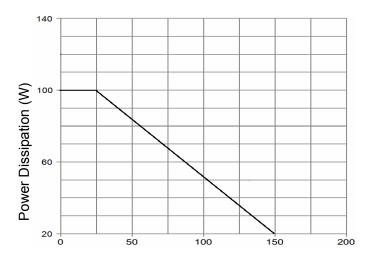
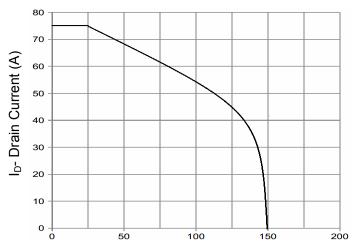


Figure 6 Capacitance vs Vds





T_J-Junction Temperature(°C) Figure 7 Power De-rating



T_J-Junction Temperature (°C) Figure 9 Current De-rating

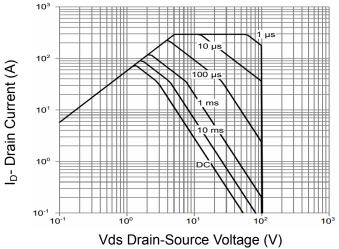


Figure 8 Safe Operation Area

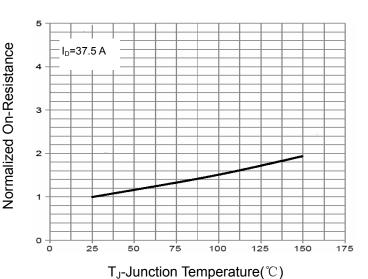
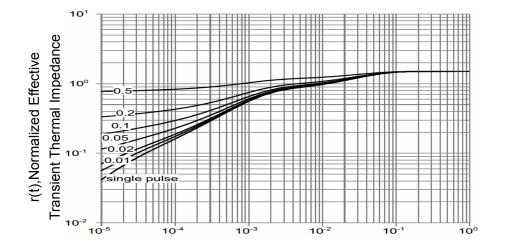


Figure 10 Rdson-Junction Temperature

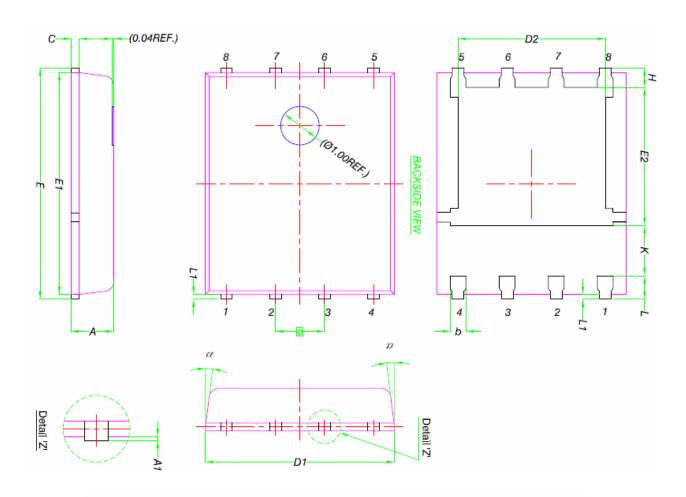


Square Wave Pluse Duration(sec)

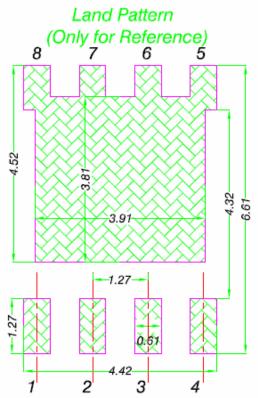
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



	MILLIMETERS				
DIM.	MIN.	NOM.	MAX.		
Α	0.90	1.00	1.10		
A1	0	-	0.05		
b	0.33	0.41	0.51		
С	0.20	0.25	0.30		
D1	4.80	4.90	5.00		
D2	3.61	3.81	3.96		
Ε	5.90	6.00	6.10		
E1	5.70	5.75	5.80		
E2	3.38	3.58	3.78		
е	1.27 BSC				
Н	0.41	0.51	0.61		
K	1.10	-	-		
L	0.51	0.61	0.71		
L1	0.06	0.13	0.20		
α	α 0 °		12°		





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